


PRODUCT / PROCESS CHANGE NOTIFICATION

1. PCN basic data

1.1 Company		STMicroelectronics International N.V
1.2 PCN No.	MDG/22/13482	
1.3 Title of PCN	STM32G0B0x, STM32G0B1x and STM32G0C1x 512K - product enhancement	
1.4 Product Category	STM32G0B0x, STM32G0B1x, STM32G0C1x	
1.5 Issue date	2022-06-28	

2. PCN Team

2.1 Contact supplier	
2.1.1 Name	NEMETH KRISZTINA
2.1.2 Phone	+49 89460062210
2.1.3 Email	krisztina.nemeth@st.com
2.2 Change responsibility	
2.2.1 Product Manager	Ricardo Antonio DE SA EARP
2.1.2 Marketing Manager	Veronique BARLATIER
2.1.3 Quality Manager	Pascal NARCHE

3. Change

3.1 Category	3.2 Type of change	3.3 Manufacturing Location
General Product & Design	Die redesign : Mask or mask set change with new die design like metallization (specifically chip frontside) or bug fix	TSMC FAB14 (Taiwan)

4. Description of change

	Old	New
4.1 Description	<p>STM32G0B0x, STM32G0B1x and STM32G0C1x - (Die467- cut1.0 revision A) product has limitation as described in Errata Sheets.</p> <ul style="list-style-type: none"> - ES0547 (Rev 1 - January 12 2021) for STM32G0B0CE/KE/RE/VE device - ES0548 (Rev 1 - January 12 2021) for STM32G0B1xB/xC/xE device - ES0549 (Rev 1 - January 12 2021) for STM32G0C1xC/xE device <p>Limitations:</p> <ul style="list-style-type: none"> - Device lock in case of OPT bytes mismatch - Flash memory PCROP area weakness - SRAM contents corrupted upon entry in Standby - ADC Offset calibration improvements - Wakeup capability GPIO's not configurable after wakeup 	<p>STM32G0B0x, STM32G0B1x and STM32G0C1x 512K (Die467- cut1.1 revision Z) product enhancement fixes those limitations as described in Errata Sheet.</p> <ul style="list-style-type: none"> - ES0547 (Rev 2 - April 11 2022) for STM32G0B0CE/KE/RE/VE device - ES0548 (Rev 2 - April 11 2022) for STM32G0B1xB/xC/xE device - ES0549 (Rev 2 - April 11 2022) for STM32G0C1xC/xE device <p>Enhancements:</p> <ul style="list-style-type: none"> - Device lock in case of OPT bytes mismatch - fixed - Flash memory PCROP area weakness - fixed - TIM16 and TIM17 are unduly clocked by SYSCLK - fixed - ADC Offset calibration improved - Wakeup capability GPIO's not configurable after wakeup - fixed - Device IDCODE updated
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	Functionality enhancement as indicated in Errata Sheets: ES0547, ES0548 & ES0549	

5. Reason / motivation for change

5.1 Motivation	The strategy of ST GPM Division is to increase the robustness and improve performances, quality and functionality of our products. This is achieved by introducing new die revision for STM32G0B0x , STM32G0B1x and STM32G0Cx products.
5.2 Customer Benefit	SERVICE IMPROVEMENT

6. Marking of parts / traceability of change

6.1 Description	Traceability ensured by ST internal tools. Die revision changes from "A" to "Z" on Package Marking
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7. Timing / schedule	
7.1 Date of qualification results	2022-06-30
7.2 Intended start of delivery	2022-08-15
7.3 Qualification sample available?	Upon Request

8. Qualification / Validation		
8.1 Description	13482 MDG-MCD-RER1918_STM32G0Bx_Die 467_Reliability Evaluation Report_rev1.4.pdf	
8.2 Qualification report and qualification results	Available (see attachment)	Issue Date 2022-06-28

9. Attachments (additional documentations)
13482 Public product.pdf 13482 MDG-MCD-RER1918_STM32G0Bx_Die 467_Reliability Evaluation Report_rev1.4.pdf 13482 PCN13482_Additional information.pdf

10. Affected parts		
10.1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	STM32G0B0CET6	
	STM32G0B0KET6	
	STM32G0B0RET6	
	STM32G0B0VET6	
	STM32G0B1CBT6	
	STM32G0B1CET6	
	STM32G0B1CET6N	
	STM32G0B1CEU6	
	STM32G0B1KCT6	
	STM32G0B1KET6	
	STM32G0B1KEU6	
	STM32G0B1RET6	
	STM32G0B1VET6	
	STM32G0C1RET6	
	STM32G0B1CCT6	
	STM32G0B1RCT6	

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Public Products List

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PCN Title : STM32G0B0x, STM32G0B1x and STM32G0C1x 512K - product enhancement

PCN Reference : MDG/22/13482

Subject : Public Products List

Dear Customer,

Please find below the Standard Public Products List impacted by the change.

STM32G0B0RET6	STM32G0C1KCU6	STM32G0B1RCT7
STM32G0B1KCT6N	STM32G0B1CET6	STM32G0C1MCT6
STM32G0C1CET6	STM32G0B1KET6N	STM32G0B1VEI6
STM32G0C1CEU6TR	STM32G0B1KCU7TR	STM32G0C1RCT3
STM32G0B0CET6TR	STM32G0B1KET6	STM32G0C1MET6
STM32G0C1KCU6N	STM32G0B1VBT6	STM32G0B1RCI6N
STM32G0B1KCT6	STM32G0B1CBU6TR	STM32G0C1KET6N
STM32G0B1VCT6	STM32G0B1KBT6	STM32G0C1VET6
STM32G0B1CET6TR	STM32G0B1RET6	STM32G0B1RBI6N
STM32G0B1MBT6	STM32G0B1VET6	STM32G0B1KCU6
STM32G0B1RBT6	STM32G0C1KEU6N	STM32G0B1KBU6
STM32G0B1CCU6TR	STM32G0B1KEU7TR	STM32G0B1CCU6N
STM32G0B1CCT6TR	STM32G0B1REI6N	STM32G0C1KCT6N
STM32G0B1CCU6NTR	STM32G0B0VET6	STM32G0B1RBT6N
STM32G0B1KEU6	STM32G0B1CBU6	STM32G0C1KEU6
STM32G0B1KBU3N	STM32G0B1CBT6	STM32G0B1CBU3
STM32G0B1CEU6N	STM32G0B1KEU6N	STM32G0B1VBI6
STM32G0B1KCU7	STM32G0B1RCT6TR	STM32G0B1RET6N
STM32G0B1CCU6	STM32G0B1MET6	STM32G0B1CBU6N
STM32G0B0CET6	STM32G0C1CCU6	STM32G0B1CET6N
STM32G0B1CEU6	STM32G0C1CEU6	STM32G0B1KEU7
STM32G0C1RCT6	STM32G0B1KBU6N	STM32G0C1VCT6
STM32G0C1RET6	STM32G0B1KCU6N	STM32G0B1CBT6N
STM32G0B1MCT6	STM32G0B1RCT6	STM32G0B1KBU3NTR
STM32G0C1KET6	STM32G0B1RCI6NTR	STM32G0B0RET6TR
STM32G0B1KBT6N	STM32G0B1NEY6TR	STM32G0B1CCT6
STM32G0B0KET6		



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